19-3869; Rev 1; 1/11

Low-Voltage, High-Accuracy, Quad Window Voltage Detectors in Thin QFN

General Description

The MAX16008/MAX16009 are adjustable quad window voltage detectors in a small thin QFN package. These devices are designed to provide a higher level of system reliability by monitoring multiple supply voltages and providing a fault signal when any of the voltages exceed their overvoltage thresholds or fall below their undervoltage thresholds.

These devices offer user-adjustable thresholds that allow voltages to be monitored down to 0.4V. These devices allow the upper and lower trip thresholds of each window detector to be set externally with the use of three external resistors.

Each monitored threshold has an independent open-drain output for signaling a fault condition. The outputs can be wire OR'ed together to provide a single fault output. The open-drain outputs are internally pulled up with a 30µA current, but can be externally driven to other voltage levels for interfacing to other logic levels.

Both devices feature a margin input to disable the outputs during margin testing or any other time after power-up operations. The MAX16009 offers a reset output that deasserts after a reset timeout period after all voltages are within their threshold specifications. The reset timeout is internally set to 140ms (min), but can be externally adjusted to other reset timeouts using an external capacitor. In addition, the MAX16009 offers a manual reset input.

All devices are offered in a 4mm x 4mm TQFN package and are fully specified from -40°C to +125°C.

Applications

Storage Equipment

Networking/Telecommunications Equipment

Multivoltage ASICs

Servers

Pin Configurations and Selector Guide appear at end of data sheet.

Features

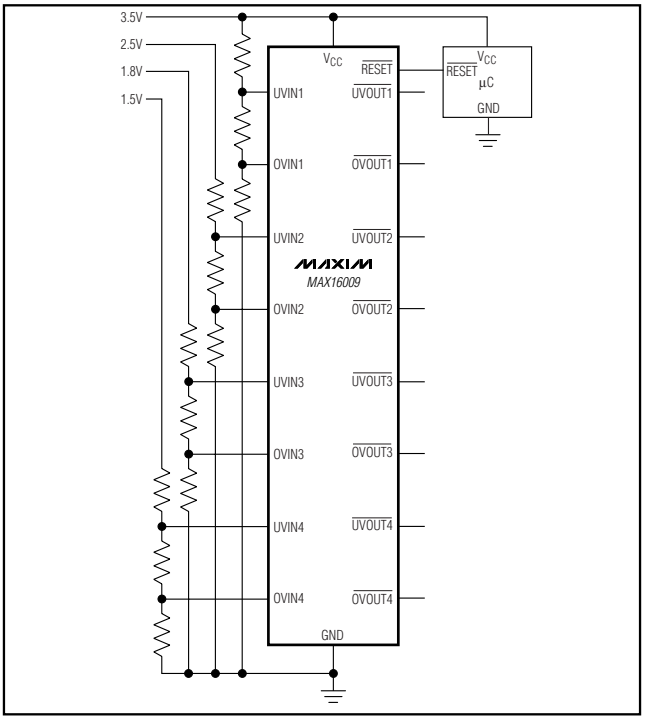
- **Monitor Four Undervoltage/Overvoltage Conditions**
- **1.5% Accuracy Over Temperature**
- **User-Adjustable Thresholds (Down to 0.4V)**
- **Open-Drain Outputs with Internal Pullups Reduce the Number of External Components**
- **Manual Reset Input (MAX16009)**
- **Margin Enable Input**
- **Fixed or Adjustable $\overline{\text{RESET}}$ Timeout (MAX16009)**
- **Guaranteed Correct Output Logic State Down to V_{CC} = 1V**
- **Fully Specified from -40°C to +125°C**
- **Small, 4mm x 4mm TQFN Package**

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX16008TP+	-40°C to +125°C	20 TQFN
MAX16009TG+	-40°C to +125°C	24 TQFN

+Denotes a lead(Pb)-free/RoHS-compliant package.
For tape-and-reel, add a "T" after the "+." Tape-and-reel are offered in 2.5k increments.

Typical Operating Circuit



Low-Voltage, High-Accuracy, Quad Window Voltage Detectors in Thin QFN

ABSOLUTE MAXIMUM RATINGS

V_{CC}, $\overline{OVOUT\_}$, $\overline{UVOUT\_}$, $\overline{RESET}$, UVIN_, OVIN_ to GND .....-0.3V to +6V
$\overline{MARGIN}$, $\overline{MR}$, TOL, SRT to GND.....-0.3V to (V_{CC} + 0.3V)
Input/Output Current ($\overline{RESET}$, $\overline{MARGIN}$, SRT, $\overline{MR}$, $\overline{UVOUT\_}$, $\overline{OVOUT\_}$) .....±20mA
Continuous Power Dissipation (T_A = +70°C)
20-Pin Thin QFN (derate 16.9mW/°C above +70°C) 1355mW
24-Pin Thin QFN (derate 16.9mW/°C above +70°C) 1666mW
Operating Temperature Range .....-40°C to +125°C
Junction Temperature .....+150°C
Storage Temperature Range .....-65°C to +150°C
Lead Temperature (soldering, 10s) .....+300°C
Soldering Temperature (reflow) .....+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = 2.0V to 5.5V, TOL = GND, T_A = -40°C to +125°C, unless otherwise specified. Typical values are at V_{CC} = 3.3V, T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Operating Voltage Range	V_{CC}	(Note 2)	1.0		5.5	V
Supply Current (Note 3)	I_{CC}	V_{CC} = 3.3V, outputs deasserted		45	65	µA
		V_{CC} = 5V, outputs deasserted		45	70	
UVLO (Undervoltage Lockout)	V_{UVLO}	V_{CC} rising	1.62	1.8	1.98	V
UVIN_/OVIN_						
Adjustable Threshold (UVIN_ Falling/OVIN_ Rising)	V_{TH}		0.388	0.394	0.400	V
UVIN_/OVIN_ Hysteresis	V_{TH_HYS}	UVIN_ falling/OVIN_ rising (percentage of the threshold)		0.5		% V_{TH}
UVIN_/OVIN_ Input Current	I_{IB}		-100		+100	nA
$\overline{RESET}$						
Reset Timeout	t_{RP}	SRT = V_{CC}	140	200	280	ms
		C_{SRT} = 1500pF (Note 4)	2.43	3.09	3.92	
		C_{SRT} = 100pF		0.206		
		C_{SRT} = open		0.05		
SRT Ramp Current	I_{SRT}	V_{SRT} = 0V	460	600	740	nA
SRT Threshold	V_{TH_SRT}		1.173	1.235	1.293	V
SRT Hysteresis				100		mV
UVIN_/OVIN_ to Reset Delay	t_{RD}	UVIN_ falling/OVIN_ rising		20		µs

ELECTRICAL CHARACTERISTICS (continued)

(V_{CC} = 2.0V to 5.5V, TOL = GND, T_A = -40°C to +125°C, unless otherwise specified. Typical values are at V_{CC} = 3.3V, T_A = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
$\overline{RESET}$ Output-Voltage Low	V_{OL}	V_{CC} = 3.3V, I_{SINK} = 10mA, $\overline{RESET}$ asserted			0.30	V
		V_{CC} = 2.5V, I_{SINK} = 6mA, $\overline{RESET}$ asserted			0.30	
		V_{CC} = 1.2V, I_{SINK} = 50µA, $\overline{RESET}$ asserted			0.30	
$\overline{RESET}$ Output-Voltage High	V_{OH}	$V_{CC} \geq$ 2.0V, I_{SOURCE} = 6µA, $\overline{RESET}$ deasserted	0.8 x V_{CC}			V
$\overline{MR}$ Input-Voltage Low	V_{IL}				0.3 x V_{CC}	V
$\overline{MR}$ Input-Voltage High	V_{IH}		0.7 x V_{CC}			V
$\overline{MR}$ Minimum Pulse Width			1			µs
$\overline{MR}$ Glitch Rejection				100		ns
$\overline{MR}$ to $\overline{RESET}$ Delay				200		ns
$\overline{MR}$ Pullup Resistance			12	20	28	kΩ
OUTPUTS ($\overline{UVOUT}$_/$\overline{OVOUT}$_)						
$\overline{UVOUT}$_, $\overline{OVOUT}$_ Output-Voltage Low	V_{OL}	V_{CC} = 3.3V, I_{SINK} = 2mA			0.30	V
		V_{CC} = 2.5V, I_{SINK} = 1.2mA			0.30	
$\overline{OVOUT}$_, $\overline{OVOUT}$_ Output-Voltage High	V_{OH}	$V_{CC} \geq$ 2.0V, I_{SOURCE} = 6µA	0.8 x V_{CC}			V
UVIN_/OVIN_ to $\overline{UVOUT}$_/$\overline{OVOUT}$_ Propagation Delay	t_D	(V_{TH} - 100mV) to (V_{TH} + 100mV)		20		µs
DIGITAL LOGIC						
TOL Input-Voltage Low	V_{IL}				0.3 x V_{CC}	V
TOL Input-Voltage High	V_{IH}		0.7 x V_{CC}			V
TOL Input Current		TOL = V_{CC}			100	nA
$\overline{MARGIN}$ Input-Voltage Low	V_{IL}				0.3 x V_{CC}	V
$\overline{MARGIN}$ Input-Voltage High	V_{IH}		0.7 x V_{CC}			V
$\overline{MARGIN}$ Pullup Resistance		Pulled up to V_{CC}	12	20	28	kΩ
$\overline{MARGIN}$ Delay Time	t_{MD}	Rising or falling (Note 5)		50		µs

Note 1: Devices are tested at T_A = +25°C and guaranteed by design for T_A = T_{MIN} to T_{MAX}.

Note 2: The outputs are guaranteed to be in the correct logic state down to V_{CC} = 1V.

Note 3: Measured with $\overline{MR}$ and $\overline{MARGIN}$ unconnected.

Note 4: The minimum and maximum specifications for this parameter are guaranteed by using the worse case of the SRT current and SRT threshold specifications. Do not set the reset timeout period to more than 1.12s.

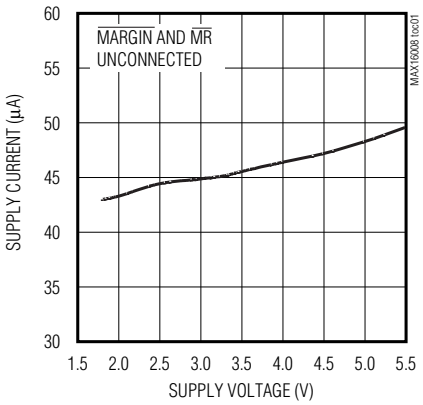
Note 5: Amount of time required for logic to lock/unlock outputs from margin testing

Low-Voltage, High-Accuracy, Quad Window Voltage Detectors in Thin QFN

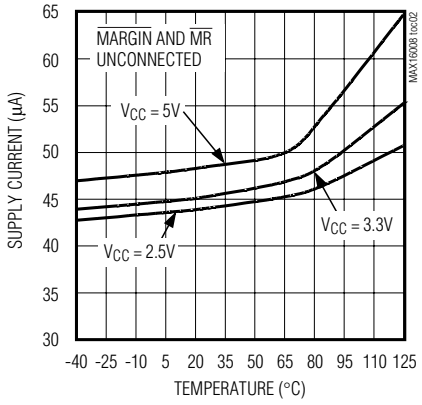
Typical Operating Characteristics

(V_{CC} = 3.3V, T_A = +25°C, unless otherwise noted.)

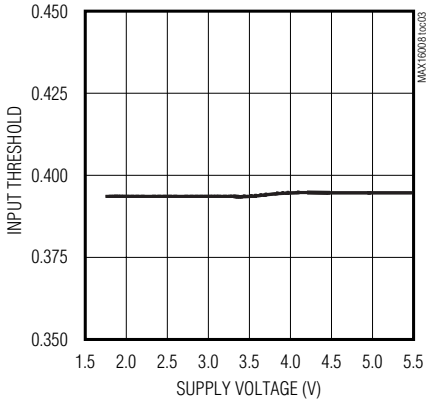
SUPPLY CURRENT vs. SUPPLY VOLTAGE



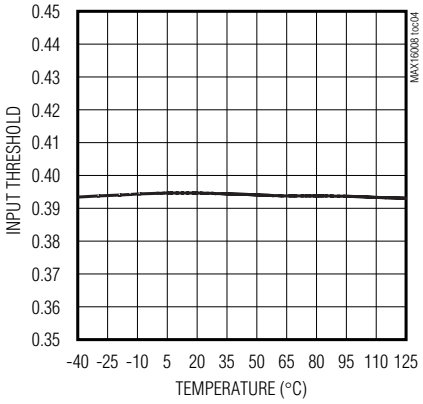
SUPPLY CURRENT vs. TEMPERATURE



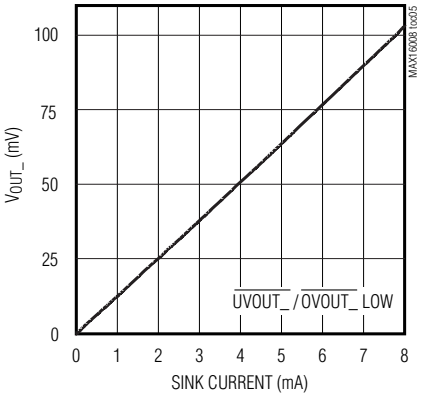
UVIN_/OVIN_ THRESHOLD vs. SUPPLY VOLTAGE



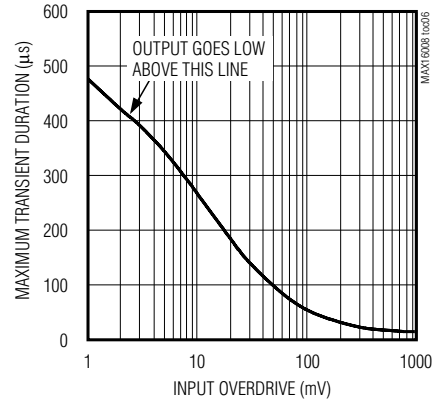
UVIN_/OVIN_ THRESHOLD vs. TEMPERATURE



OUTPUT VOLTAGE vs. SINK CURRENT



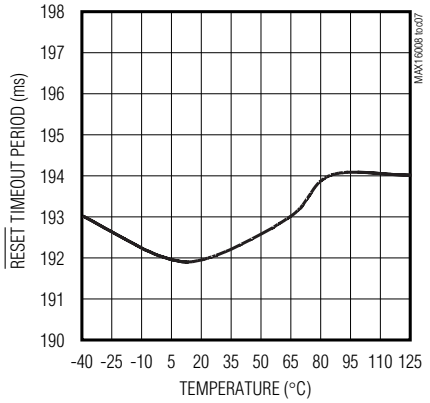
MAXIMUM TRANSIENT DURATION vs. INPUT OVERDRIVE



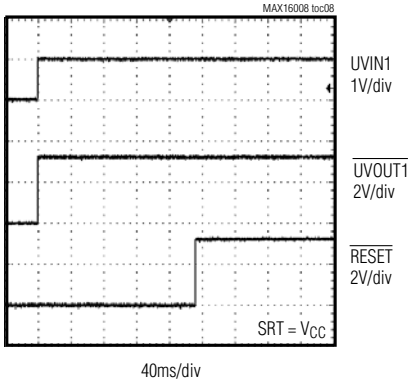
Typical Operating Characteristics (continued)

(V_{CC} = 3.3V, T_A = +25°C, unless otherwise noted.)

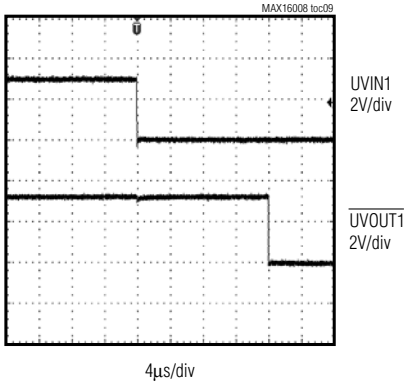
$\overline{\text{RESET}}$ TIMEOUT PERIOD vs. TEMPERATURE



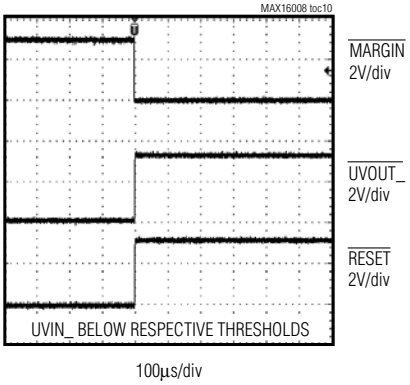
$\overline{\text{RESET}}$ TIMEOUT DELAY



UVIN_ TO $\overline{\text{UVOUT}}$_ DELAY TIME



$\overline{\text{MARGIN}}$ ENABLE FUNCTION



Low-Voltage, High-Accuracy, Quad Window Voltage Detectors in Thin QFN

Pin Description

PIN		NAME	FUNCTION
MAX16008	MAX16009		
1	1	UVIN3	Undervoltage Threshold Input 3. When the voltage on UVIN3 falls below its threshold, $\overline{UVOUT3}$ asserts low.
2	2	OVIN3	Overvoltage Threshold Input 3. When the voltage on OVIN3 rises above its threshold, $\overline{OVOUT3}$ asserts low.
3	3	UVIN4	Undervoltage Threshold Input 4. When the voltage on UVIN4 falls below its threshold, $\overline{UVOUT4}$ asserts low.
4	4	OVIN4	Overvoltage Threshold Input 4. When the voltage on OVIN4 rises above its threshold, $\overline{OVOUT4}$ asserts low.
5	6	GND	Ground
6, 20	7, 24	V_{CC}	Unmonitored Power to the Device
7	8	$\overline{UVOUT3}$	Active-Low Undervoltage Output 3. When the voltage at UVIN3 falls below its threshold, $\overline{UVOUT3}$ asserts low and stays asserted until the voltage at UVIN3 exceeds its threshold. The open-drain output has a 30µA internal pullup to V_{CC}.
8	9	$\overline{OVOUT3}$	Active-Low Overvoltage Output 3. When the voltage at OVIN3 rises above its threshold, $\overline{OVOUT3}$ asserts low and stays asserted until the voltage at OVIN3 falls below its threshold. The open-drain output has a 30µA internal pullup to V_{CC}.
9	10	$\overline{UVOUT4}$	Active-Low Undervoltage Output 4. When the voltage at UVIN4 falls below its threshold, $\overline{UVOUT4}$ asserts low and stays asserted until the voltage at UVIN4 exceeds its threshold. The open-drain output has a 30µA internal pullup to V_{CC}.
10	11	$\overline{OVOUT4}$	Active-Low Overvoltage Output 4. When the voltage at OVIN4 rises above its threshold, $\overline{OVOUT4}$ asserts low and stays asserted until the voltage at OVIN4 falls below its threshold. The open-drain output has a 30µA internal pullup to V_{CC}.
11	14	$\overline{MARGIN}$	Active-Low Margin Enable Input. Pull $\overline{MARGIN}$ low to deassert all outputs (go into high state) regardless of the voltage at any monitored input.
12	15	$\overline{OVOUT2}$	Active-Low Overvoltage Output 2. When the voltage at OVIN2 rises above its threshold, $\overline{OVOUT2}$ asserts low and stays asserted until the voltage at OVIN2 falls below its threshold. The open-drain output has a 30µA internal pullup to V_{CC}.

Pin Description (continued)

PIN		NAME	FUNCTION
MAX16008	MAX16009		
13	16	$\overline{UVOUT2}$	Active-Low Undervoltage Output 2. When the voltage at UVIN2 falls below its threshold, $\overline{UVOUT2}$ asserts low and stays asserted until the voltage at UVIN2 exceeds its threshold. The open-drain output has a 30µA internal pullup to V_{CC}.
14	17	$\overline{OVOUT1}$	Active-Low Overvoltage Output 1. When the voltage at OVIN1 rises above its threshold, $\overline{OVOUT1}$ asserts low and stays asserted until the voltage at OVIN1 falls below its threshold. The open-drain output has a 30µA internal pullup to V_{CC}.
15	18	$\overline{UVOUT1}$	Active-Low Undervoltage Output 1. When the voltage at UVIN1 falls below its threshold, $\overline{UVOUT1}$ asserts low and stays asserted until the voltage at UVIN1 exceeds its threshold. The open-drain output has a 30µA internal pullup to V_{CC}.
16	20	UVIN1	Undervoltage Threshold Input 1. When the voltage on UVIN1 falls below its threshold, $\overline{UVOUT1}$ asserts low.
17	21	OVIN1	Overvoltage Threshold Input 1. When the voltage on OVIN1 rises above its threshold, $\overline{OVOUT1}$ asserts low.
18	22	UVIN2	Undervoltage Threshold Input 2. When the voltages on UVIN2 falls below its threshold, $\overline{UVOUT2}$ asserts low.
19	23	OVIN2	Overvoltage Threshold Input 2. When the voltage on OVIN2 rises above its threshold, $\overline{OVOUT2}$ asserts low.
—	5	N.C.	Not Internally Connected
—	12	$\overline{MR}$	Active-Low Manual Reset Input. Pull $\overline{MR}$ low to assert $\overline{RESET}$ low. $\overline{RESET}$ remains low for the reset timeout period after $\overline{MR}$ is deasserted. $\overline{MR}$ is pulled up to V_{CC} through a 20kΩ resistor.
—	13	SRT	Set Reset Timeout Input. Connect a capacitor from SRT to GND to set the reset timeout period. The reset timeout period can be calculated as follows: Reset Timeout (s) = 2.06 x 10^6 (Ω) x C_{SRT} (F). Do not set the reset timeout period to more than 1.12s. For the internal timeout period of 140ms (min), connect SRT to V_{CC}.
—	19	$\overline{RESET}$	Active-Low Reset Output. $\overline{RESET}$ asserts low when the voltage on any of the UVIN_ inputs falls below their respective thresholds, the voltage on any of the OVIN_ inputs goes above its respective threshold, or $\overline{MR}$ is asserted. $\overline{RESET}$ remains asserted for at least the minimum reset timeout after all monitored UVIN_ inputs exceed their respective thresholds, all OVIN_ inputs fall below their respective thresholds, and $\overline{MR}$ is deasserted. This open-drain output has a 30µA internal pullup.
—	—	EP	Exposed Pad. EP is internally connected to GND. Connect EP to the ground plane to provide a low thermal resistance path from the IC junction to the PC board. Do not use as the only electrical connection to GND.

Low-Voltage, High-Accuracy, Quad Window Voltage Detectors in Thin QFN

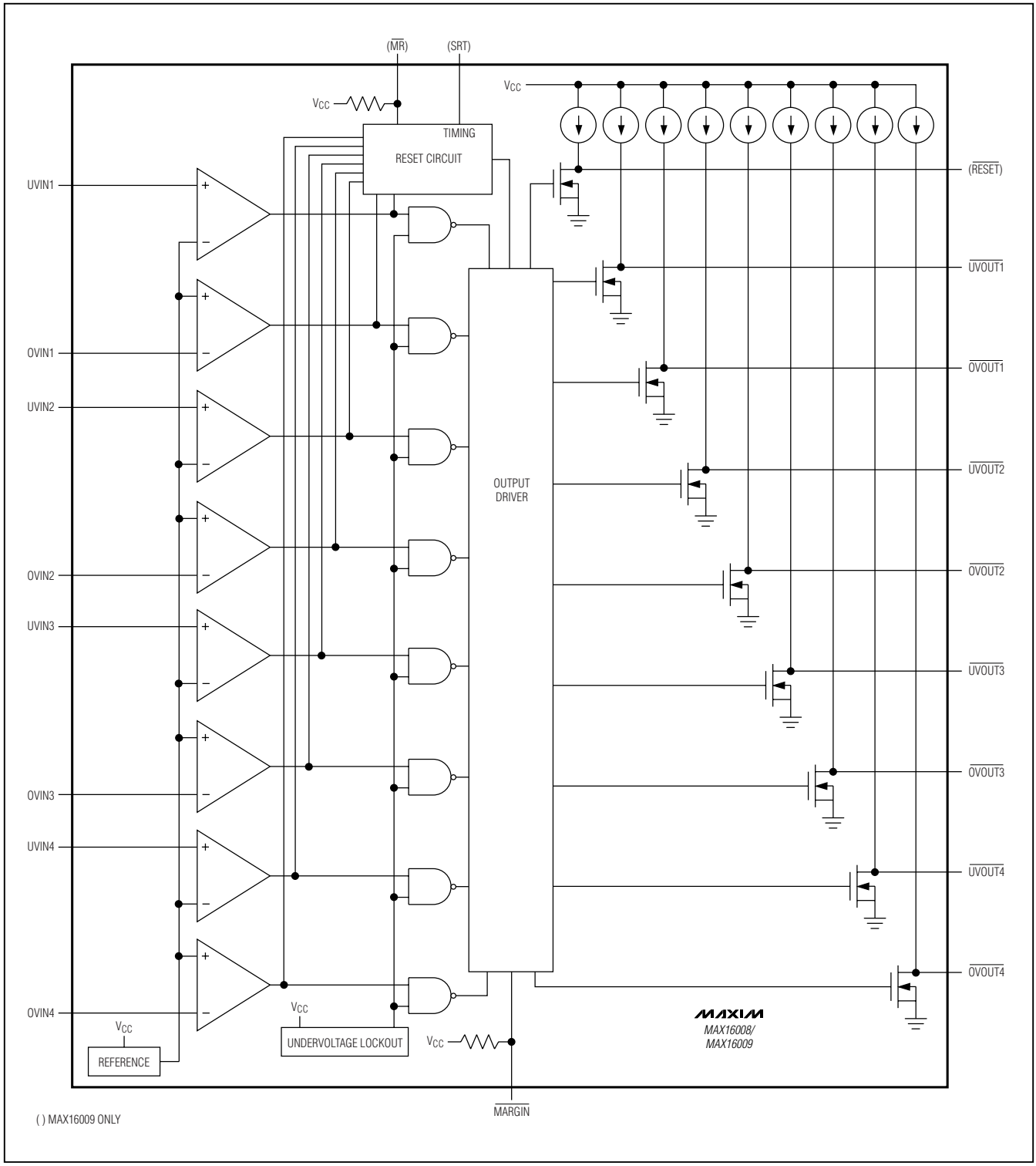


Figure 1. Functional Diagram

Detailed Description

The MAX16008/MAX16009 are adjustable quad window voltage detectors in a small thin QFN package. These devices are designed to provide a higher level of system reliability by monitoring multiple supply voltages and providing a fault signal when any of the voltages exceeds its overvoltage threshold or falls below its undervoltage threshold.

These devices offer user-adjustable thresholds that allow voltages to be monitored down to 0.4V. The devices allow the upper and lower trip thresholds of each window detector to be set externally with the use of three external resistors.

Each monitored threshold has an independent open-drain output for signaling a fault condition. The outputs can be wire OR'ed together to provide a single fault output. The open-drain outputs are internally pulled up with a 30µA current, but can be externally driven to other voltage levels for interfacing to other logic levels.

Both devices feature a margin input to disable the outputs during margin testing or any other time after power-up operations. The MAX16009 offers a reset output that deasserts after a reset timeout period after all voltages are within their threshold specification. The reset timeout is internally set to 140ms (min), but can be externally adjusted to other reset timeouts using an external capacitor. In addition, the MAX16009 offers a manual reset input.

Applications Information

Voltage Monitoring

The MAX16008/MAX16009 feature undervoltage and overvoltage comparators for window detection (see Figure 2). $\overline{UVOUT\_}$/$\overline{OVOUT\_}$ deassert high when the monitored voltage is within the "selected window." When the monitored voltage falls below the lower limit of the window ($V_{TRIPLOW}$), $\overline{UVOUT\_}$ asserts low; or if the monitored voltage exceeds the upper limit ($V_{TRIPHIGH}$), $\overline{OVOUT\_}$ asserts low. The application in Figure 2 shows the MAX16008/MAX16009 enabling the DC-DC converter when the monitored voltage is in the selected window.

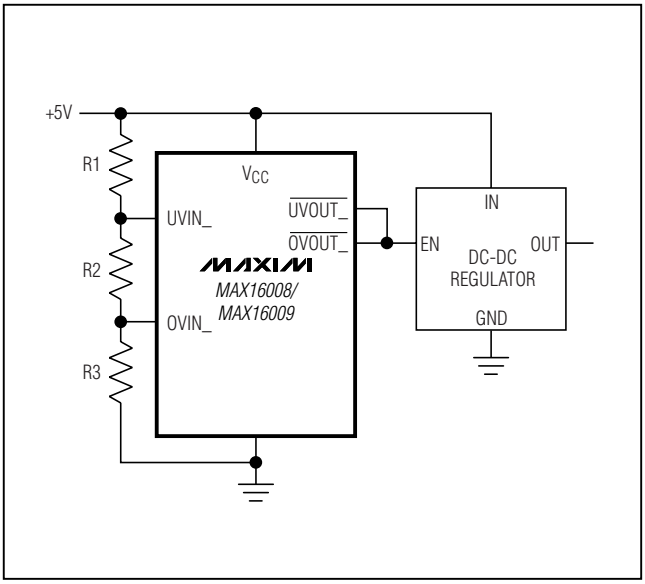


Figure 2. MAX16008/MAX16009 Monitor Circuit

The resistor values R1, R2, and R3 can be calculated as shown:

$$V_{TRIPLOW} = V_{TH}\left(\frac{R_{TOTAL}}{R2 + R3}\right)$$

$$V_{TRIPHIGH} = V_{TH}\left(\frac{R_{TOTAL}}{R3}\right)$$

where R_{TOTAL} = R1 + R2 + R3.

Use the following steps to determine the values for R1, R2, and R3:

1) Choose a value for R_{TOTAL}, the sum of R1, R2, and R3. Because the MAX16008/MAX16009 have very low input bias current (2nA typ), R_{TOTAL} can be up to 2MΩ. Large-value resistors help minimize power consumption. Lower-value resistors can be used to maintain overall accuracy.

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Use the following formulas to calculate the error:

$$E_{UV}(\%) = \frac{I_{IB}\left(R_1 + \frac{R_1 R_3}{R_2 + R_3}\right)}{V_{TRIPLOW}} \times 100$$

$$E_{OV}(\%) = \frac{I_{IB}(R_2 + (2 \times R_1))}{V_{TRIPHIGH}} \times 100$$

where E_{UV} and E_{OV} are the undervoltage and overvoltage error (in %), respectively.

2) Calculate R3 based on R_{TOTAL} and the desired upper trip point:

$$R3 = \frac{V_{TH} \times R_{TOTAL}}{V_{TRIPHIGH}}$$

3) Calculate R2 based on R_{TOTAL}, R3, and the desired lower trip point:

$$R2 = \frac{V_{TH} \times R_{TOTAL}}{V_{TRIPLOW}} - R3$$

4) Calculate R1 based on R_{TOTAL}, R3, and R2:

$$R1 = R_{TOTAL} - R2 - R3$$

Overvoltage Shutdown

The MAX16008/MAX16009 are ideal for overvoltage-shutdown applications. Figure 3 shows a typical circuit for this application using a pass p-channel MOSFET.

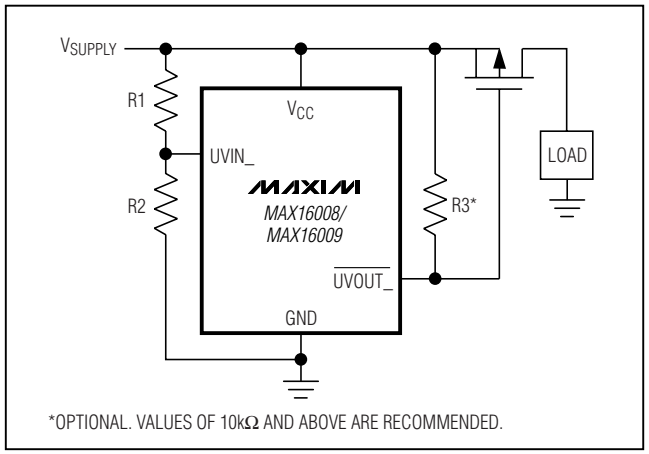


Figure 3. Overvoltage Shutdown Circuit (with External Pass MOSFET)

The MAX16008/MAX16009 are powered directly from the system voltage supply. Select R1 and R2 to set the trip voltage. When the supply voltage remains below the selected threshold, a low logic level on $\overline{UVOUT\_}$ turns on the p-channel MOSFET. In the case of an overvoltage event, $\overline{UVOUT\_}$ goes high turning off the MOSFET, and shuts down the power to the load.

Figure 4 shows a similar application using a fuse and a silicon-controlled rectifier (SCR). An overvoltage event turns on the SCR and shorts the supply to ground. The surge of current through the short circuit blows the fuse and terminates the current to the load. Select R3 so that the gate of the SCR is properly biased when $\overline{UVOUT\_}$ goes high.

Unused Inputs

Any unused UVIN_ inputs must be connected to V_{CC}, and any unused OVIN_ inputs must be connected to GND.

$\overline{UVOUT\_}$/$\overline{OVOUT\_}$ Outputs

$\overline{UVOUT\_}$ and $\overline{OVOUT\_}$ outputs assert low when UVIN_ and OVIN_, respectively, drop below or exceed their specified thresholds. The undervoltage/overvoltage outputs are open-drain with a (30µA) internal pullup to V_{CC}. For many applications, no external pullup resistor is required to interface with other logic devices. An external pullup resistor to any voltage up to 5.5V overdrives the internal pullup if interfacing to different logic supply voltages. Internal circuitry prevents reverse current flow from the external pullup voltage to V_{CC} (Figure 5). When choosing the external pullup resistor, the resistance value should be large enough to ensure that the output can sink the necessary current during a logic-low condition and small enough to be able to overdrive the internal pullup current and meet output high specifications

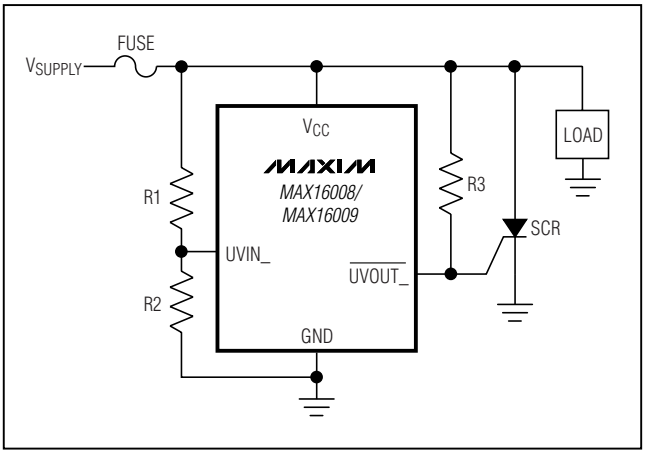


Figure 4. Overvoltage Shutdown Circuit (with SCR Fuse)

(V_{OH}). Resistor values of 50kΩ to 200kΩ can generally be used.

$\overline{\text{RESET}}$ Output (MAX16009 Only)

$\overline{\text{RESET}}$ asserts low when the voltage on any of the UVIN_ inputs falls below its respective threshold, the voltage on any of the OVIN_ inputs goes above its respective threshold, or $\overline{\text{MR}}$ is asserted. $\overline{\text{RESET}}$ remains asserted for the reset timeout period after all monitored UVIN_ inputs exceed their respective thresholds, all OVIN_ inputs fall below their respective thresholds, and $\overline{\text{MR}}$ is deasserted (see Figure 6). This open-drain output has a 30µA internal pullup.

Reset Timeout Capacitor

The reset timeout period can be adjusted to accommodate a variety of microprocessor (µP) applications from 50µs to 1.12s. Adjust the reset timeout period (t_{RP}) by connecting a capacitor (C_{SRT}) between SRT and GND. Calculate the reset timeout capacitor as follows:

$$C_{SRT}(F) = \frac{t_{RP}(s)}{\left(\frac{V_{TH\_SRT}}{I_{SRT}}\right)}$$

Do not use capacitor (C_{SRT}) values higher than 390nF.

Connect SRT to V_{CC} for a factory-programmed reset timeout of 140ms (min).

Manual Reset Input ($\overline{\text{MR}}$) (MAX16009 Only)

Many µP-based products require manual reset capability, allowing the operator, a test technician, or external logic circuitry to initiate a reset. A logic-low on $\overline{\text{MR}}$ asserts $\overline{\text{RESET}}$ low. $\overline{\text{RESET}}$ remains asserted while $\overline{\text{MR}}$ is low, and during the reset timeout period (140ms min) after $\overline{\text{MR}}$ returns high. The $\overline{\text{MR}}$ input has an internal 20kΩ pullup resistor to V_{CC}, so it can be left open if it is not used. $\overline{\text{MR}}$ can be driven with TTL or CMOS-logic levels, or with open-drain/collector outputs. Connect a normally open momentary switch from $\overline{\text{MR}}$ to GND to create a manual reset function; external debounce circuitry is not required. If $\overline{\text{MR}}$ is driven from long cables or if the device is used in a noisy environment, connecting a 0.1µF capacitor from $\overline{\text{MR}}$ to GND provides additional noise immunity.

Margin Output Disable ($\overline{\text{MARGIN}}$)

$\overline{\text{MARGIN}}$ allows system-level testing while power supplies are adjusted from their nominal voltages. Drive $\overline{\text{MARGIN}}$ low to deassert all outputs ($\overline{\text{UVOUT\_}}$,

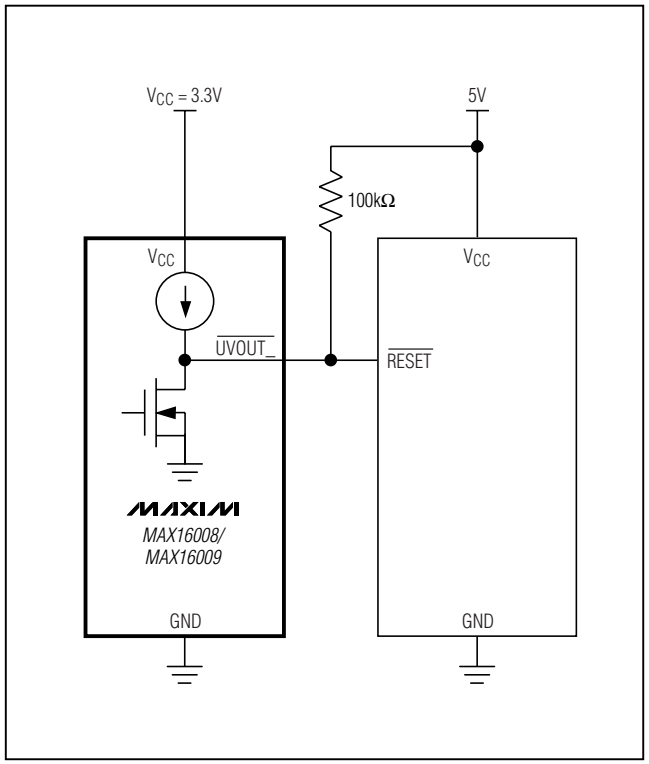


Figure 5. Interfacing to a Different Logic Supply Voltage

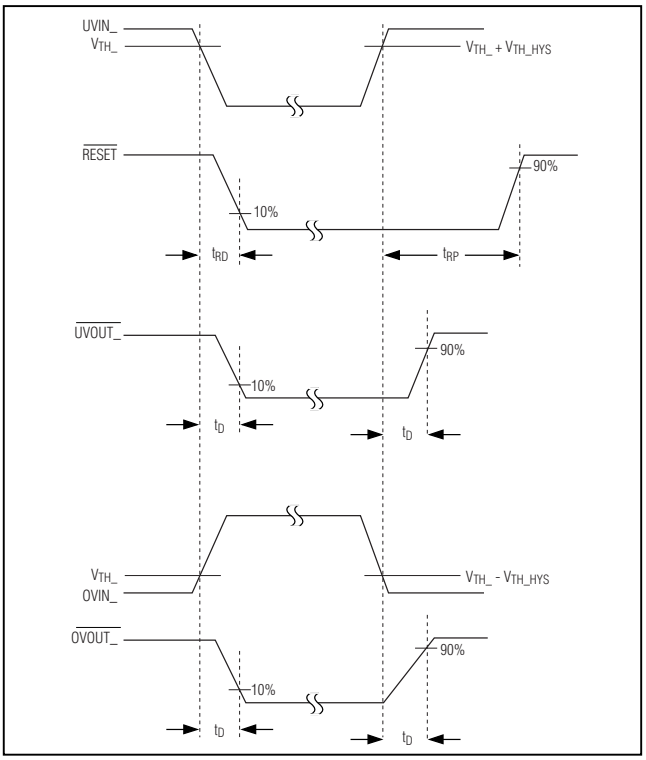


Figure 6. Output Timing Diagram

Low-Voltage, High-Accuracy, Quad Window Voltage Detectors in Thin QFN

$\overline{OVOUT\_}$, and $\overline{RESET}$) regardless of the voltage at any monitored input. The state of each output does not change while $\overline{MARGIN}$ = GND. While $\overline{MARGIN}$ is low, the IC continues to monitor all voltages. When $\overline{MARGIN}$ is deasserted, the outputs go to their monitored states after a short propagation delay. The $\overline{MARGIN}$ input is internally pulled up to V_{CC}. Leave unconnected or connect to V_{CC} if unused.

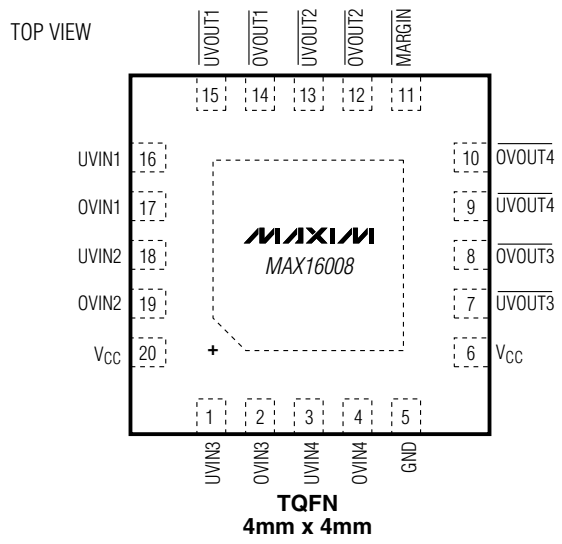
Power-Supply Bypassing

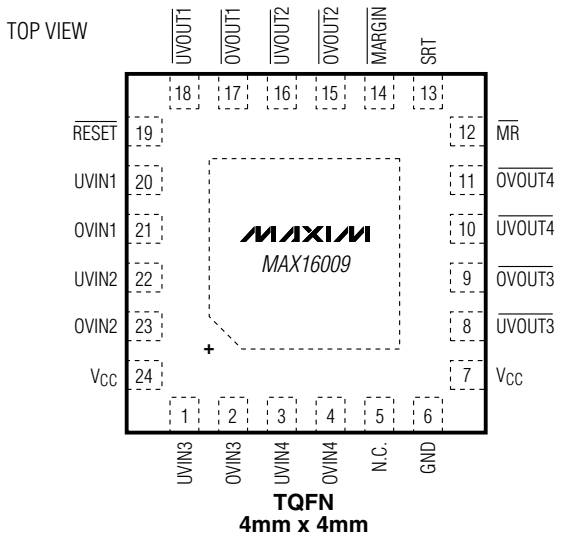
The MAX16008/MAX16009 operate from a 2.0V to 5.5V supply. An undervoltage lockout ensures that the outputs are in the correct states when the UVLO is exceeded. In noisy applications, bypass V_{CC} to ground with a 0.1µF capacitor as close to the device as possible. In addition, the additional capacitor improves transient immunity. For fast-rising V_{CC} transients, additional capacitance may be required.

Selector Guide

PART	NUMBER OF MONITORED LEVELS	UNDERVOLTAGE/ OVERVOLTAGE THRESHOLDS	$\overline{RESET}$	ADJUSTABLE RESET TIMEOUT	$\overline{MR}$
MAX16008	4	Adjustable	—	—	—
MAX16009	4	Adjustable	✔	✔	✔

Pin Configurations





Package Information

For the latest package outline information and land patterns (footprints), go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
20 TQFN-EP	T2044+3	21-0139	90-0037
24 TQFN-EP	T2444+4	21-0139	90-0022

Low-Voltage, High-Accuracy, Quad Window Voltage Detectors in Thin QFN

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	10/05	Initial release	—
1	1/11	Added soldering temperature in the *Absolute Maximum Rating* section and added symbol in *Electrical Characteristics* table	2

Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

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- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

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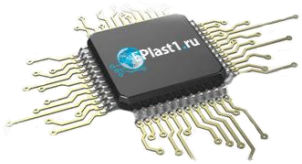
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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